Trench gate field-stop IGBT, V series 600 V, 20 A very high speed

TO-3PF

Sc12850_no_tab
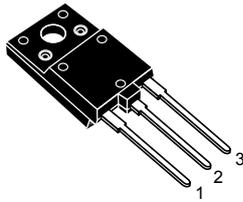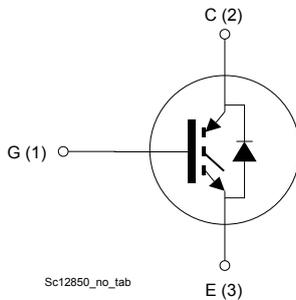
Features

- Maximum junction temperature: T_J = 175 °C
- Tail-less switching off
- $V_{CE(sat)}$ = 1.8 V (typ.) @ I_C = 20 A
- Tight parameter distribution
- Safe paralleling
- Low thermal resistance
- Very fast soft recovery antiparallel diode

Applications

- Photovoltaic inverters
- Uninterruptible power supply
- Welding
- Power factor correction
- Very high frequency converters

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the V series IGBTs, which represent an optimum compromise between conduction and switching losses to maximize the efficiency of very high frequency converters. Furthermore, the positive $V_{CE(sat)}$ temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Product status link
STGFW20V60DF

Product summary	
Order code	STGFW20V60DF
Marking	G20V60DF
Package	TO-3PF
Packing	Tube

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage (V_{GE} = 0 V)	600	V
I_C	Continuous collector current at T_C = 25 °C	40	A
	Continuous collector current at T_C = 100 °C	20	A
I_{CP} [1]	Pulsed collector current	80	A
V_{GE}	Gate-emitter voltage	±20	V
I_F	Continuous forward current at T_C = 25 °C	40	A
	Continuous forward current at T_C = 100 °C	20	A
I_{FP} [1]	Pulsed forward current	80	A
V_{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T_C = 25 °C)	3.5	kV
P_{TOT}	Total power dissipation at T_C = 25 °C	86.7	W
T_{STG}	Storage temperature range	-55 to 150	°C
T_J	Operating junction temperature range	-55 to 175	°C

1. *Pulse width is limited by maximum junction temperature.*

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance, junction-to-case IGBT	1.73	°C/W
	Thermal resistance, junction-to-case diode	2.55	
R_{thJA}	Thermal resistance, junction-to-ambient	50	°C/W

2 Electrical characteristics

T_J = 25 °C unless otherwise specified.

Table 3. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	V_{GE} = 0 V, I_C = 2 mA	600			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_{GE} = 15 V, I_C = 20 A		1.8	2.2	V
		V_{GE} = 15 V, I_C = 20 A, T_J = 125 °C		2.15		
		V_{GE} = 15 V, I_C = 20 A, T_J = 175 °C		2.3		
V_F	Forward on-voltage	I_F = 20 A		1.7	2.2	V
		I_F = 20 A, T_J = 125 °C		1.55		
		I_F = 20 A, T_J = 175 °C		1.3		
$V_{GE(th)}$	Gate threshold voltage	V_{CE} = V_{GE}, I_C = 1 mA	5	6	7	V
I_{CES}	Collector cut-off current	V_{GE} = 0 V, V_{CE} = 600 V			25	µA
I_{GES}	Gate-emitter leakage current	V_{CE} = 0 V, V_{GE} = ±20 V			250	µA

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	V_{CE} = 25 V, f = 1 MHz, V_{GE} = 0 V	-	2800	-	pF
C_{oes}	Output capacitance		-	110	-	pF
C_{res}	Reverse transfer capacitance		-	64	-	pF
Q_g	Total gate charge	V_{CC} = 480 V, I_C = 20 A, V_{GE} = 0 to 15 V (see Figure 28. Gate charge test circuit)	-	116	-	nC
Q_{ge}	Gate-emitter charge		-	24	-	nC
Q_{gc}	Gate-collector charge		-	50	-	nC

Table 5. **IGBT switching characteristics (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V_{CE} = 400 V, I_C = 20 A, R_G = 10 Ω, V_{GE} = 15 V (see Figure 27. Test circuit for inductive load switching)	-	38	-	ns
t_r	Current rise time		-	10	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1556	-	A/μs
$t_{d(off)}$	Turn-off-delay time		-	149	-	ns
t_f	Current fall time		-	15	-	ns
E_{on} [1]	Turn-on switching energy		-	200	-	μJ
E_{off} [2]	Turn-off switching energy		-	130	-	μJ
E_{ts}	Total switching energy		-	330	-	μJ
$t_{d(on)}$	Turn-on delay time	V_{CE} = 400 V, I_C = 20 A, R_G = 10 Ω, V_{GE} = 15 V, T_J = 175 °C (see Figure 27. Test circuit for inductive load switching)	-	37	-	ns
t_r	Current rise time		-	12	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1340	-	A/μs
$t_{d(off)}$	Turn-off-delay time		-	150	-	ns
t_f	Current fall time		-	23	-	ns
E_{on} [1]	Turn-on switching energy		-	430	-	μJ
E_{off} [2]	Turn-off switching energy		-	210	-	μJ
E_{ts}	Total switching energy		-	640	-	μJ

1. *Including the reverse recovery of the diode.*
2. *Including the tail of the collector current.*

Table 6. **Diode switching characteristics (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	I_F = 20 A, V_R = 400 V, V_{GE} = 15 V, di/dt = 1000 A/μs (see Figure 27. Test circuit for inductive load switching)	-	40		ns
Q_{rr}	Reverse recovery charge		-	320		nC
I_{rrm}	Reverse recovery current		-	16		A
dI_{rr}/dt	Peak rate of fall of reverse recovery current during t_b		-	910		A/μs
E_{rr}	Reverse recovery energy		-	115		μJ
t_{rr}	Reverse recovery time	I_F = 20 A, V_R = 400 V, V_{GE} = 15 V, di/dt = 1000 A/μs, T_J = 175 °C (see Figure 27. Test circuit for inductive load switching)	-	72		ns
Q_{rr}	Reverse recovery charge		-	930		nC
I_{rrm}	Reverse recovery current		-	26		A
dI_{rr}/dt	Peak rate of fall of reverse recovery current during t_b		-	530		A/μs
E_{rr}	Reverse recovery energy		-	307		μJ

2.1 Electrical characteristics (curves)

**Figure 1. Power dissipation vs case temperature**
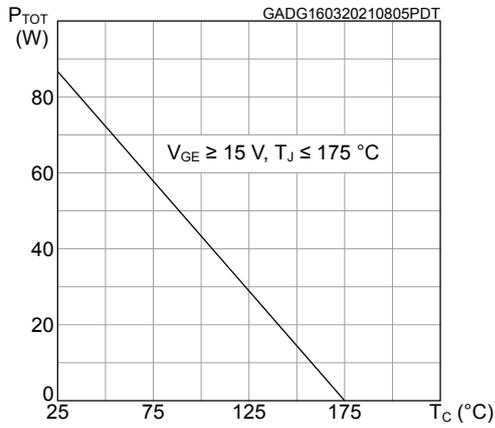

Figure 2. Collector current vs case temperature
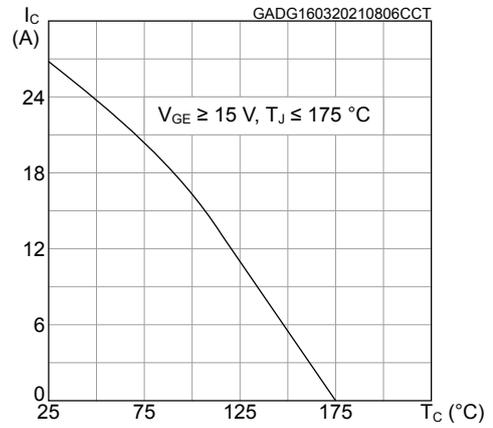

Figure 3. Output characteristics (T$_J$ = 25 °C)
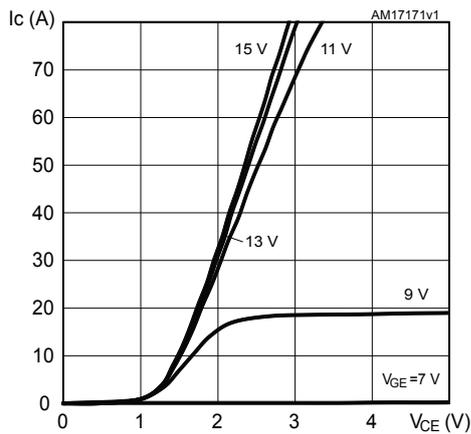
**Figure 4. Output characteristics (T$_J$ = 175 °C)**
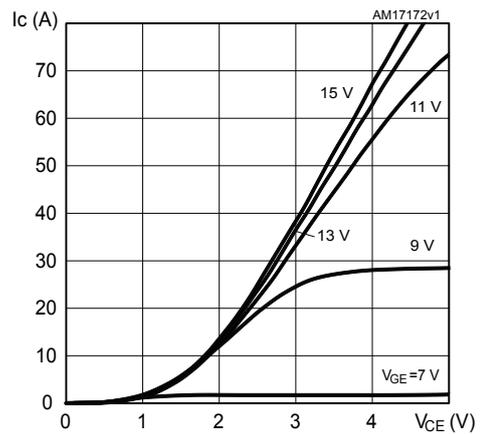
**Figure 5. V$_{CE}$(sat) vs junction temperature**
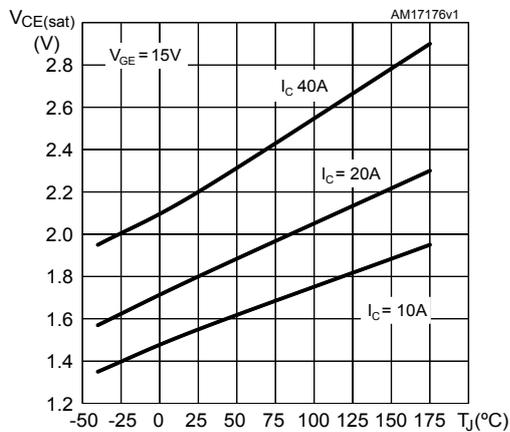
**Figure 6. V$_{CE}$(sat) vs collector current**
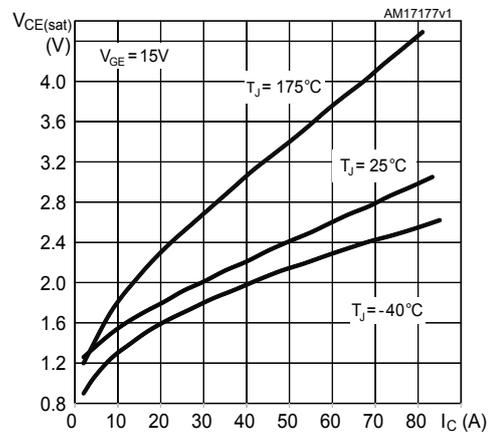
Figure 7. Transfer characteristics
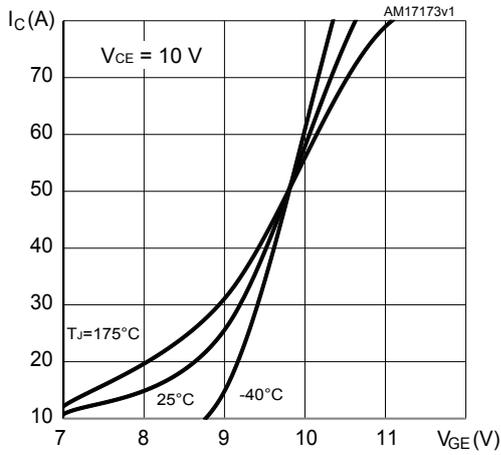
Figure 8. Diode V$_F$ vs forward current
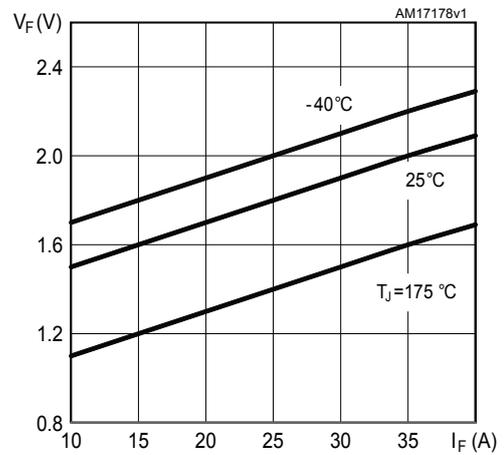
Figure 9. Normalized V$_{GE(th)}$ vs junction temperature
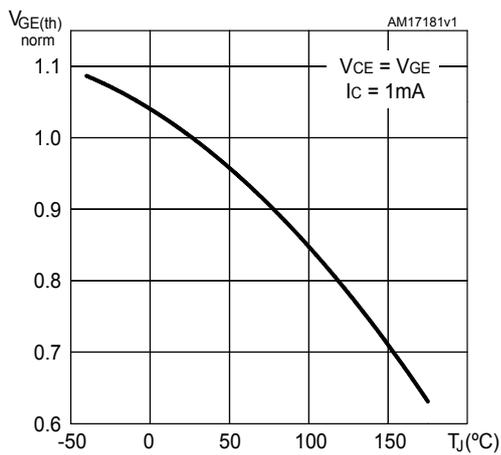
Figure 10. Normalized V$_{(BR)CES}$ vs junction temperature
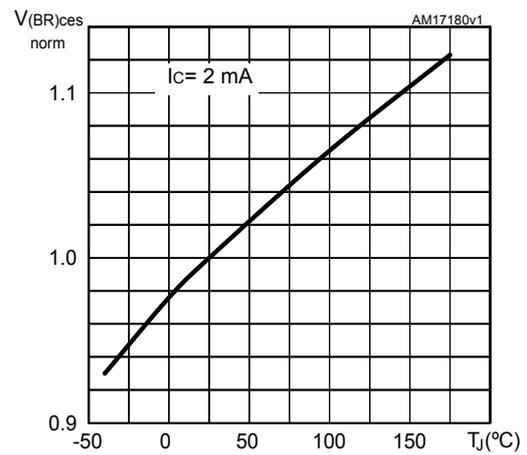
Figure 11. Capacitance variations
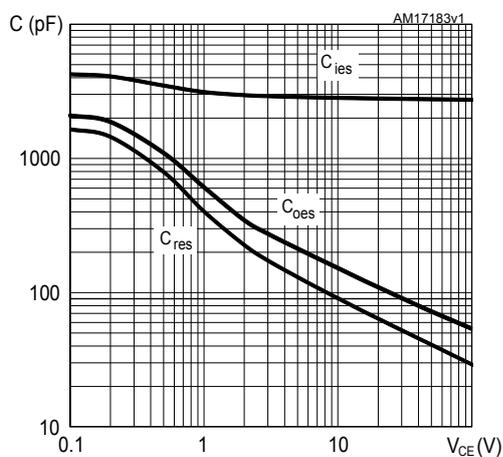
Figure 12. Gate charge vs gate-emitter voltage
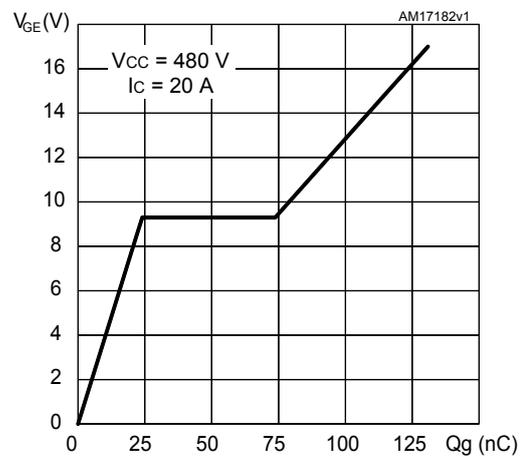
Figure 13. Switching energy vs collector current
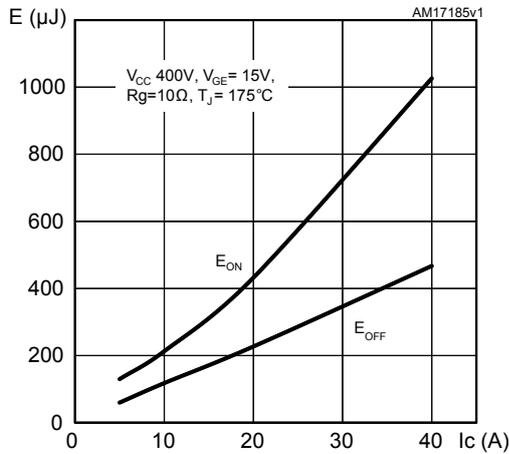
Figure 14. Switching energy vs gate resistance
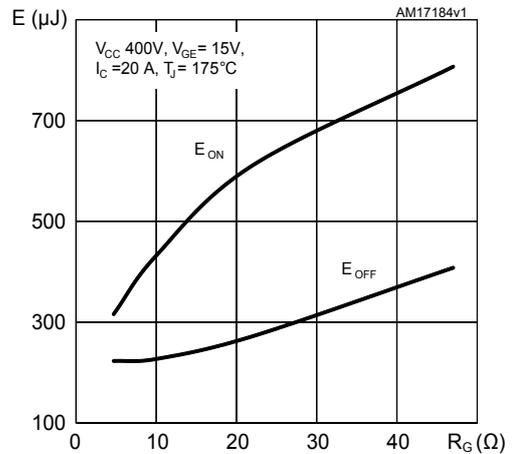
Figure 15. Switching energy vs junction temperature
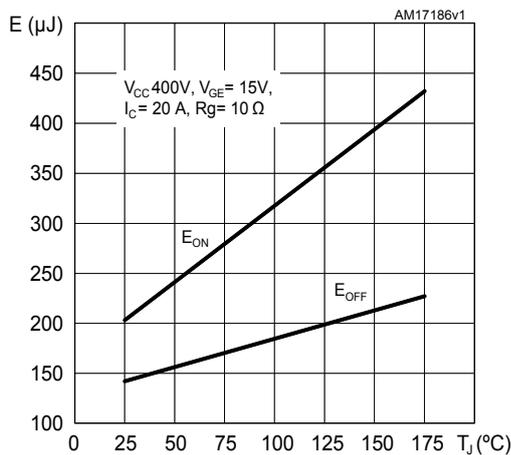
Figure 16. Switching energy vs collector emitter voltage
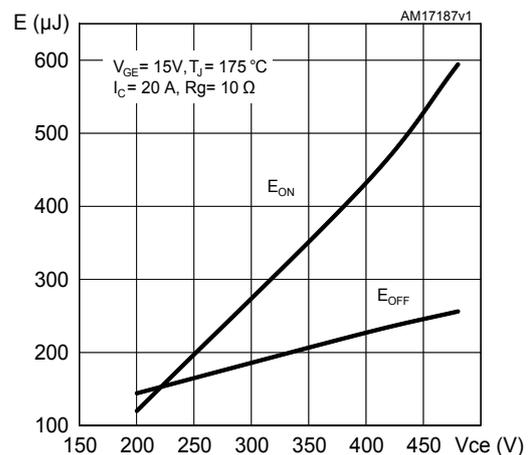
Figure 17. Switching times vs collector current
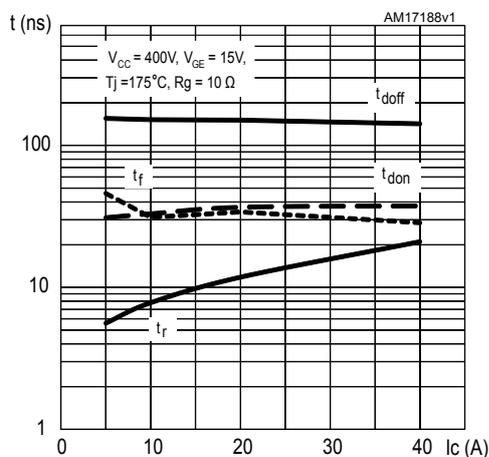
Figure 18. Switching times vs gate resistance
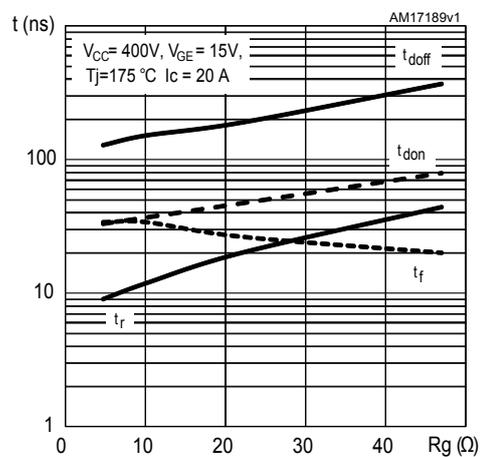
Figure 19. Reverse recovery current vs diode current slope
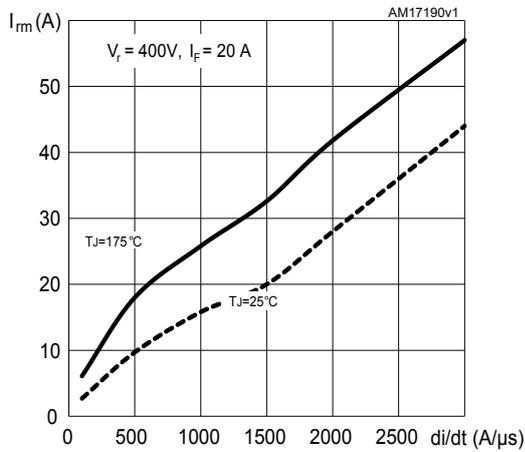
Figure 20. Reverse recovery time vs diode current slope
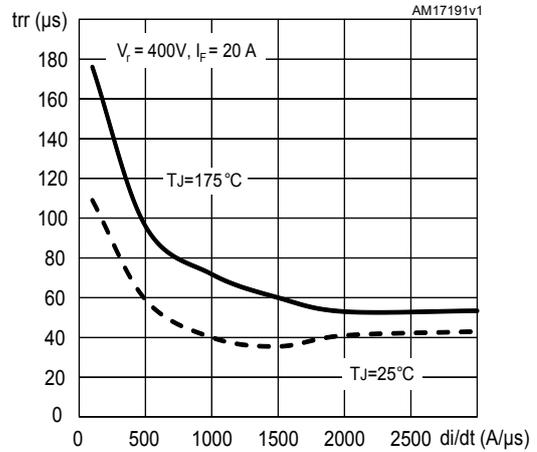
Figure 21. Reverse recovery charge vs diode current slope
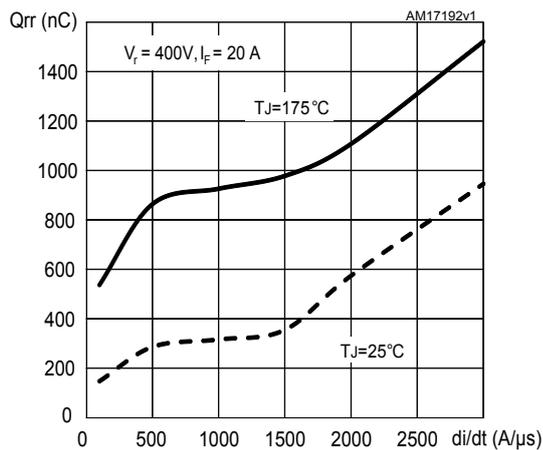
Figure 22. Reverse recovery energy vs diode current slope
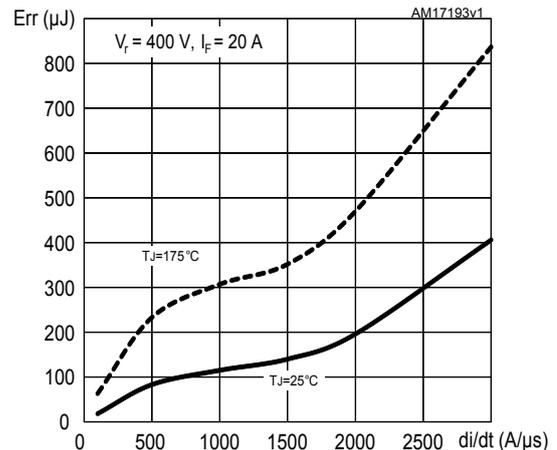

Figure 23. Safe operating area
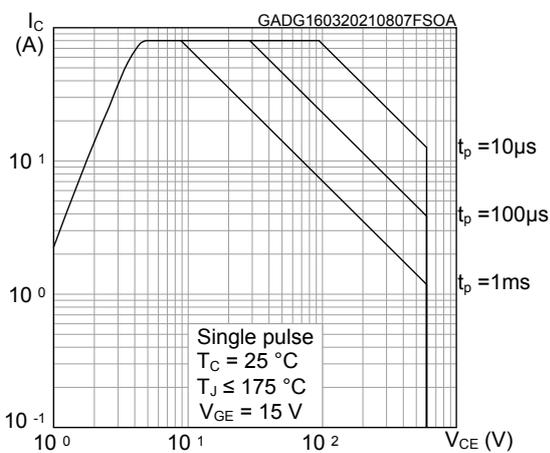

Figure 24. Collector current vs switching frequency
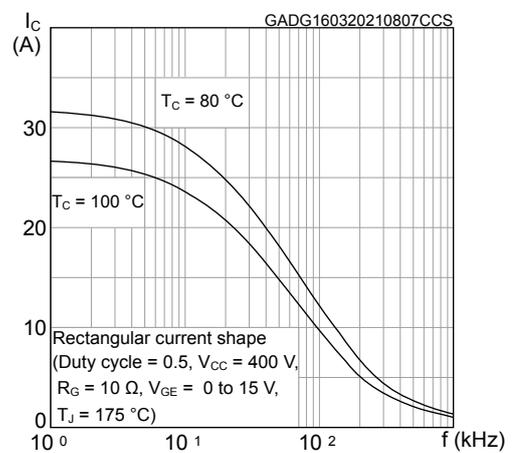
Figure 25. Thermal impedance for IGBT

ZthTOF3T_A

$Z_{th} = k*R_{thJC}$
$\delta = t_p/t$

Single pulse

$\delta=0.5$
0.2
0.1
0.05
0.02
0.01
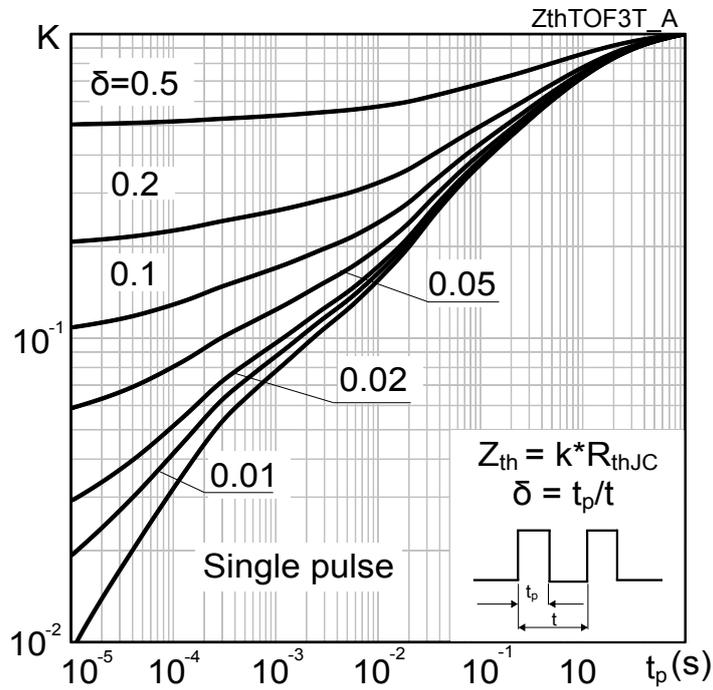
Figure 26. Thermal impedance for diode

GC20930

$Z_{th} = k*R_{thJC}$
$\delta = t_p/t$

SINGLE PULSE

$\delta = 0.5$
0.2
0.1
0.05
0.02
0.01
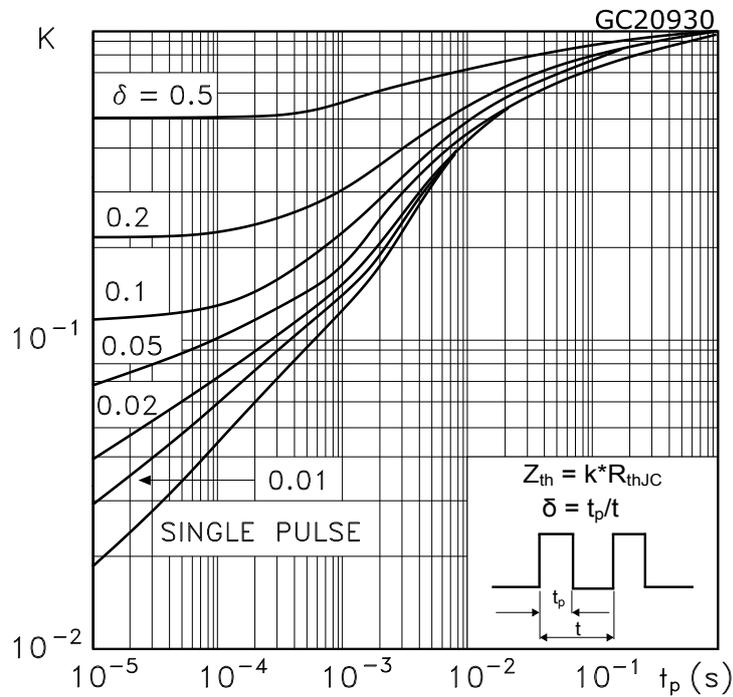
3 Test circuits

Figure 27. Test circuit for inductive load switching

AM01504v1

Figure 28. Gate charge test circuit

AM01505v1
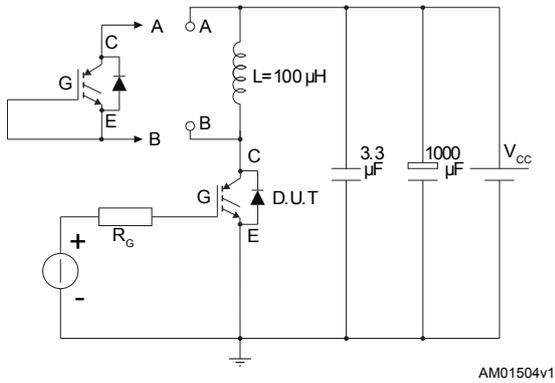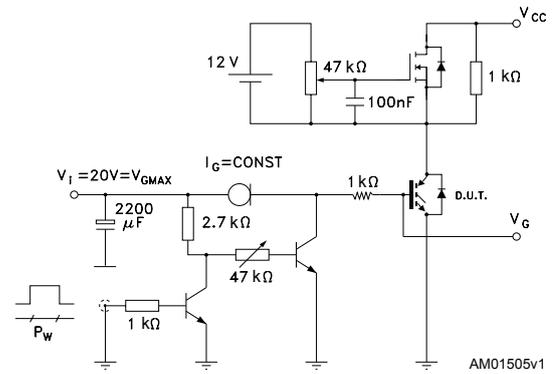
**Figure 29. Switching waveform**

AM01506v1
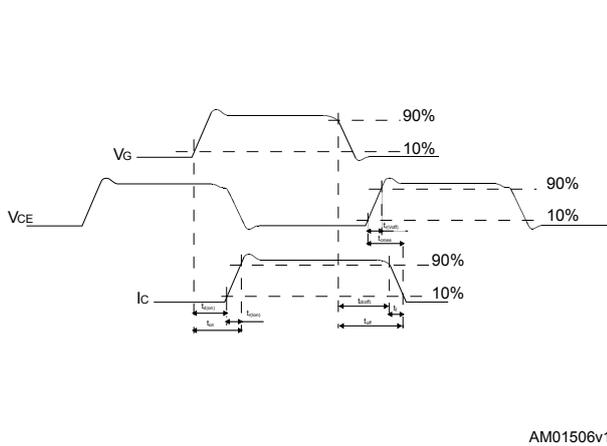
**Figure 30. Diode reverse recovery waveform**

AM01507v1
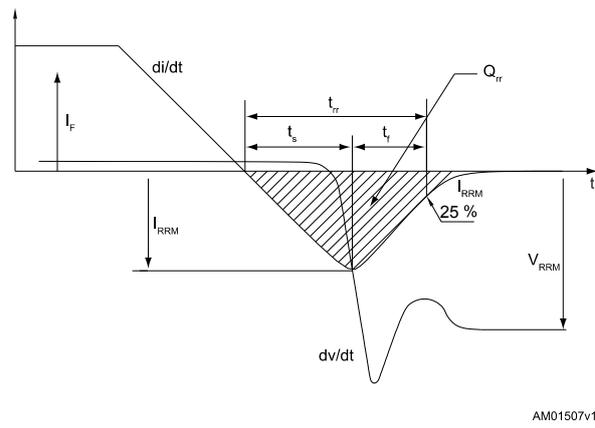
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-3PF package information

Figure 31. TO-3PF package outline
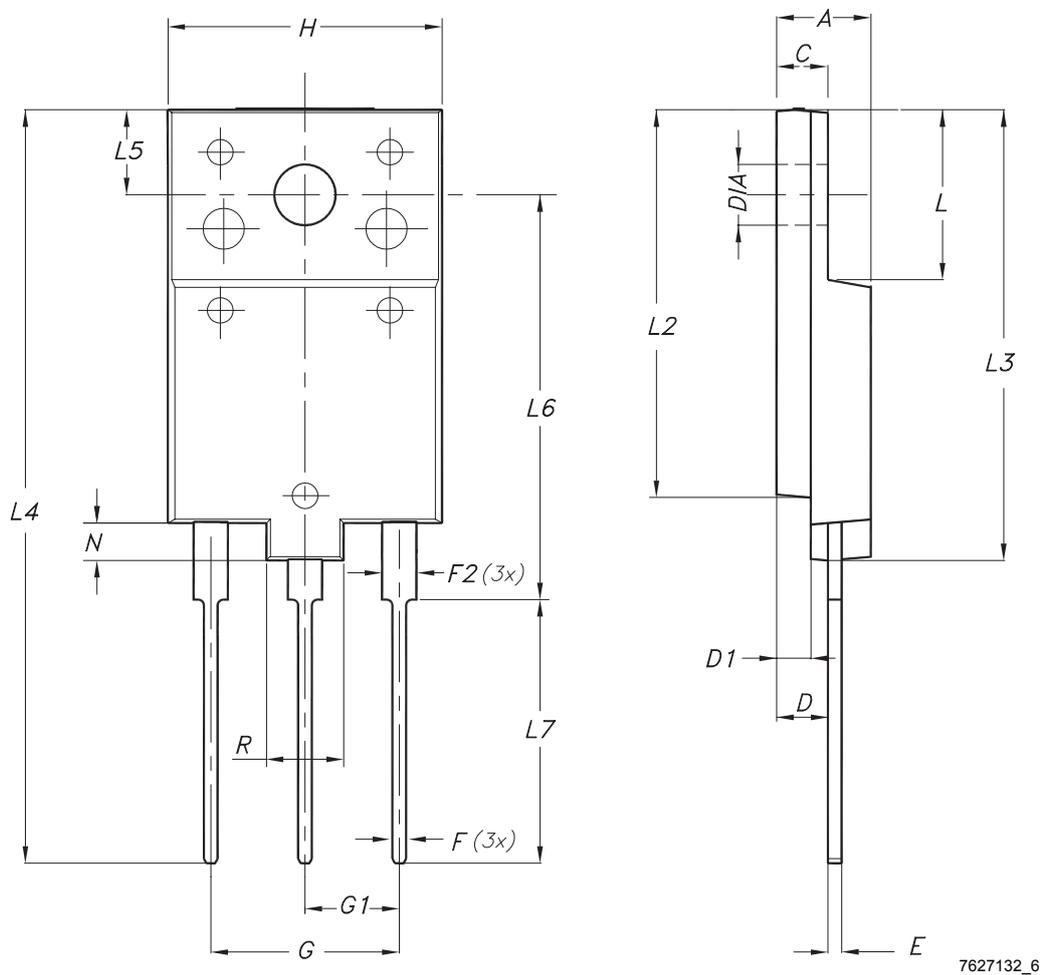
7627132_6

Table 7. TO-3PF mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	5.30		5.70
C	2.80		3.20
D	3.10		3.50
D1	1.80		2.20
E	0.80		1.10
F	0.65		0.95
F2	1.80		2.20
G	10.30		11.50
G1		5.45	
H	15.30		15.70
L	9.80	10.00	10.20
L2	22.80		23.20
L3	26.30		26.70
L4	43.20		44.40
L5	4.30		4.70
L6	24.30		24.70
L7	14.60		15.00
N	1.80		2.20
R	3.80		4.20
Dia	3.40		3.80

Revision history

Table 8. Document revision history

Date	Version	Changes
28-Mar-2014	1	Initial release
14-Feb-2017	2	Updated *Table 1: "Device summary"*. Minor text changes
19-Mar-2021	3	Updated Features in cover page. Updated Section 1 Electrical ratings. Updated Figure 1. Power dissipation vs case temperature, Figure 2. Collector current vs case temperature, Figure 23. Safe operating area and added Figure 24. Collector current vs switching frequency. Minor text changes.

Contents

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GT50JR22(STA1ES) TIG058E8-TL-H VS-CPV364M4KPBF NGTB25N120FL2WAG NGTG40N120FL2WG RJH60F3DPQ-A0#T0
APT40GR120B2SCD10 APT15GT120BRG APT20GT60BRG NGTB75N65FL2WAG NGTG15N120FL2WG IXA30RG1200DHGLB
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